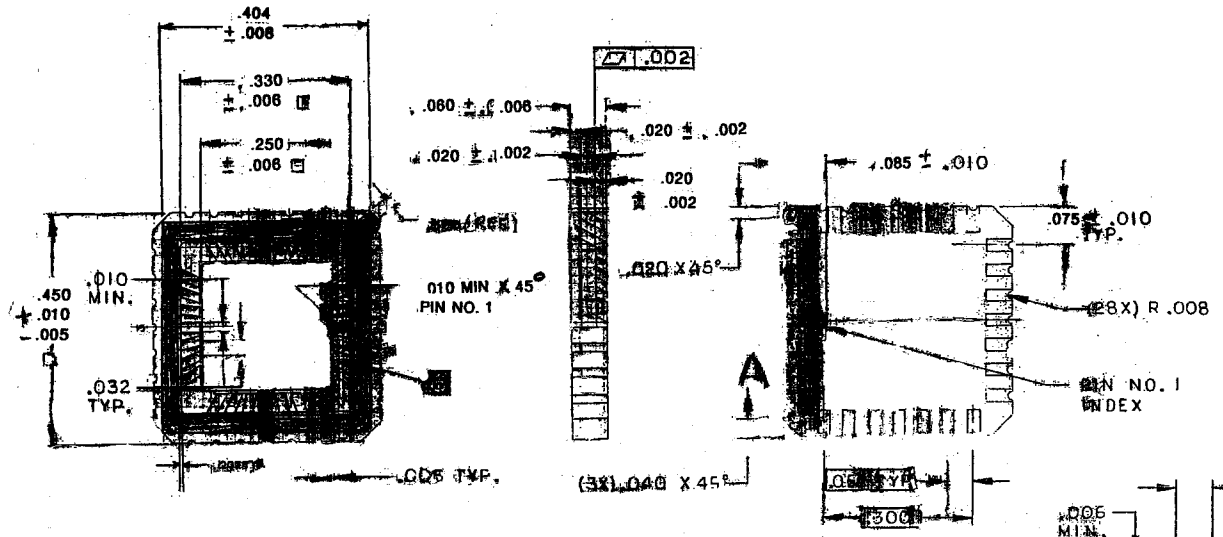
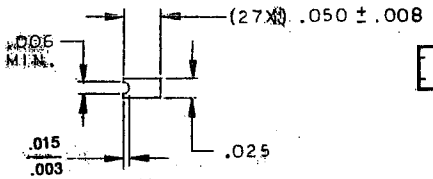
SSM P/N LCC02840





DETAIL A
SCALE: 10X
(28X)

C500420 A3

NOTES: UNLESS OTHERWISE SPECIFIED.

2. RAYTHEON MATERIAL AND SUPPLY [illegible] APPLY.

3. MATERIAL: CERAMIC BLACK ALUMINA.

4. FINISH: GOLD PLATING [illegible] NESS OVER 100 [illegible] NOMINAL THICKNESS OF NICKEL PLATING.

4. LEAD RESISTANCE TO BE LESS THAN 10 OHM MAXIMUM.

5. CURRENT LEAKAGE BETWEEN LEAD AND OTHER LEAD TO BE LESS THAN 10 NANO AMPS AT 100 [illegible] D. C.

6. CRITICAL DIMENSIONS: WIRE ATTACH LEAD BOND FINGERS TO BE A MINIMUM OF .010" WIDE X .015" LONG.

7. SEAL RING AND DIE ATTACH PAD AREA NOT ELECTRICALLY CONNECTED TO ANY LEAD.

8. SEAL RING / DIE ATTACH FLATNESS: .002 [illegible]

9. "LD" PKG., CAT. # [illegible] TS [illegible]

		STOCK NO. LL-6509 LD-6572
TITLE 28 LEADLESS CHIP CARRIER		LL LD
SCALE ~6.5	PAGE 1 OF 1	DR. NO. C500420 A3

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